



AO3407A

P-Channel Enhancement Mode Field Effect Transistor

General Description

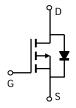
The AO3407A uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$ with low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard product AO3407A is Pb-free (meets ROHS & Sony 259 specifications).

Features

 V_{DS} (V) = -30V I_{D} = -4.3A (V_{GS} = -10V) $R_{DS(ON)}$ < 48m Ω (V_{GS} = -10V) $R_{DS(ON)}$ < 78m Ω (V_{GS} = -4.5V)

Rg,Ciss,Coss,Crss Tested





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±20	V				
Continuous Drain	T _A =25°C		-4.3					
Current A,F	T _A =70°C	I _D	-3.5	A				
Pulsed Drain Current ^B		I _{DM}	-20					
	T _A =25°C	В	1.4	W				
Power Dissipation A	T _A =70°C	$-P_{D}$	0.9					
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient AF	t ≤ 10s	ь	70	90	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	100	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	63	80	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter Conditions		Min	Тур	Max	Units			
STATIC PARAMETERS									
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1	μА			
		T _J =55°C	7		-5	μι			
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$	-1.5	-2	-2.5	V			
$I_{D(ON)}$	On state drain current	V_{GS} =-10V, V_{DS} =-5V	-30			Α			
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-4.3A		39	48	mΩ			
		T _J =125°C	2	55	68	11122			
		V_{GS} =-4.5V, I_{D} =-3A		61	78	mΩ			
g _{FS}	Forward Transconductance	ransconductance V_{DS} =-5V, I_{D} =-4.3A		11		S			
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.78	-1	V			
I _S	Maximum Body-Diode Continuous Current				-2	Α			
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance			668	830	pF			
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		126		pF			
C _{rss}	Reverse Transfer Capacitance			92		pF			
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		6	9	Ω			
SWITCHII	NG PARAMETERS								
Q _g (10V)	Total Gate Charge (10V)			12.7	16	nC			
Q _g (4.5V)	Total Gate Charge (4.5V)	V _{GS} =-10V, V _{DS} =-15V, I _D =-4.3A		6.4		nC			
Q_{gs}	Gate Source Charge	V _{GS} 10V, V _{DS} 13V, I _D 4.5A		2		nC			
Q_{gd}	Gate Drain Charge	1		4		nC			
t _{D(on)}	Turn-On DelayTime			7.7		ns			
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =3.5 Ω ,		6.8		ns			
$t_{D(off)}$	Turn-Off DelayTime	R_{GEN} =3 Ω		20		ns			
t _f	Turn-Off Fall Time]		10		ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =-4.3A, dI/dt=100A/μs		22	30	ns			
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-4.3A, dI/dt=100A/μs		15		nC			

A: The value of R $_{8JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25°C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < $300\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t \leq 10s thermal resistance rating. Rev0: Apr. 2007

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

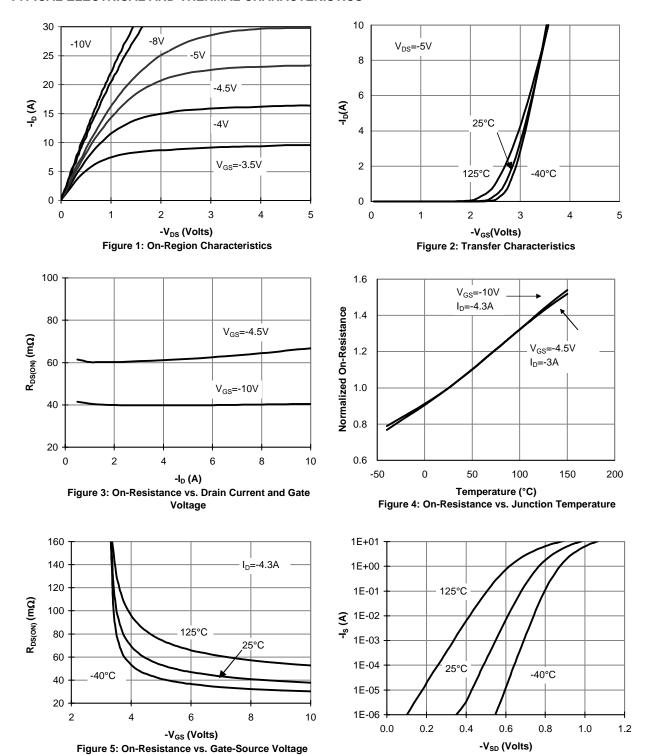


Figure 6: Body-Diode Characteristics

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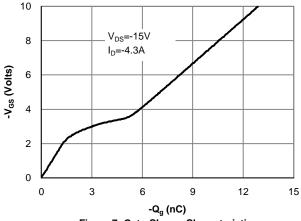


Figure 7: Gate-Charge Characteristics

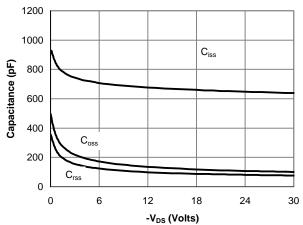


Figure 8: Capacitance Characteristics

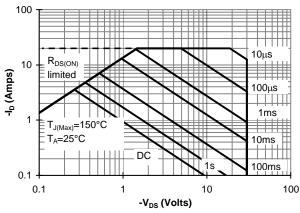


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

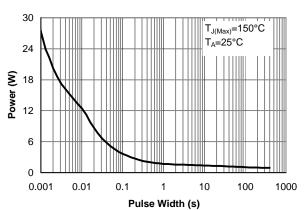


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

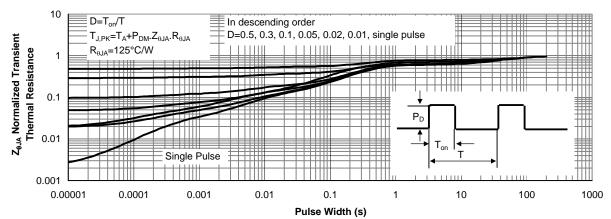


Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)